

Innogration (Suzhou) Co., Ltd.

1200W, 100V RF Power N-channel MOSFETs

Description

The VTSU011K2 is a 1200-watt, N-channel MOSFETs, designed for pulsed applications at frequencies up to 200 MHz. It's suitable for use in industrial, scientific and medical applications.

Typical Performance (In Demo Fixture): V_{DD} = 100 Volts, I_{DQ} = 500 mA,
Pulse CW, Pulse Width=1ms, Duty cycle=10%

Frequency	Gp (dB)	P _{OUT} (W)	η₀ (%)
120 MHz	26	1200	60

Features

- Common source configuration, push pull
- Excellent thermal stability, low HCI drift
- Low R_{DS(on)}
- Pb-free, RoHS-compliant



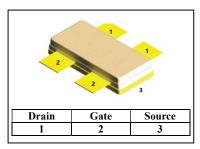


Figure 1. Pin Connection

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{(BR)DSS}$	200	V
Drain-Gate Voltage (RGS = 1M Ω)	V_{DGR}	200	V
Gate-Source Voltage	V _{GS}	-20 to +20	V
Storage Temperature Range	Tstg	-65 to 150	°C
Case Operating Temperature	T _c	150	°C
Operating Junction Temperature	TJ	200	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Junction-Case Thermal Resistance	R _{thJC}	0.078	°C/W

Table 3. ESD Protection Characteristics

Test Methodology	Class
Human Body Model (per JESD22A114)	Class 2

Table 4. Electrical Characteristics (T_{CASE} = 25 °C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
DC Characteristics					
Drain-Source Voltage	V	200	250		V
V _{GS} =0, I _{DS} =100mA	$V_{(BR)DSS}$	200	230		V
Zero Gate Voltage Drain Leakage Current				1	mA
$(V_{DS} = 100V, V_{GS} = 0 V)$	I _{DSS}			'	IIIA

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Gate-Source Leakage Current	GSS			250	nA
$(V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V})$					
Gate Threshold Voltage	V _{GS} (th)	2.0		4.0	V
$(V_{DS} = 10V, I_D = 250 \text{ mA})$	V _{GS} (In)	2.0		4.0	V
Drain-Source Voltage (On state)	\ \ \\			3.7	V
$(V_{GS} = 10V, I_D = 10 A)$	V _{DS(ON)}			3.7	V
Forward Transconductance		6			S
$(V_{DS} = 10 \text{ V}, I_D = 2.5 \text{ A})$	g FS	U			3
Common Source Input Capacitance			568		,r
$(V_{GS} = 0V, V_{DS} = 100 V, f = 1 MHz)$	C _{ISS}		300		pF
Common Source Output Capacitance			125		,,r
(V _{GS} = 0V, V _{DS} =100 V, f = 1 MHz)	Coss		135		pF
Common Source Feedback Capacitance			0		nE
$(V_{GS} = 0V, V_{DS} = 100 V, f = 1 MHz)$	C _{RSS}		9		pF

Functional Tests (In Demo Test Fixture, 50 ohm system) V_{DD} = 100 Vdc, I_{DQ} = 2×250mA, f = 120 MHz, Pulse CW, Pulse Width=1ms, Duty cycle=10%.

Output Power	P _{OUT}	1000	1200	W
Power Gain@ Pout=1000W	Gp		26	dB
Drain Efficiency@ P _{OUT} =1000W	η _D		60	%

TYPICAL CHARACTERISTICS

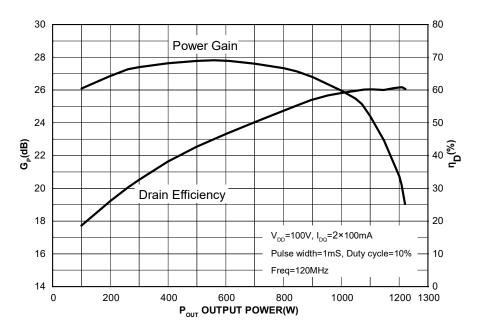
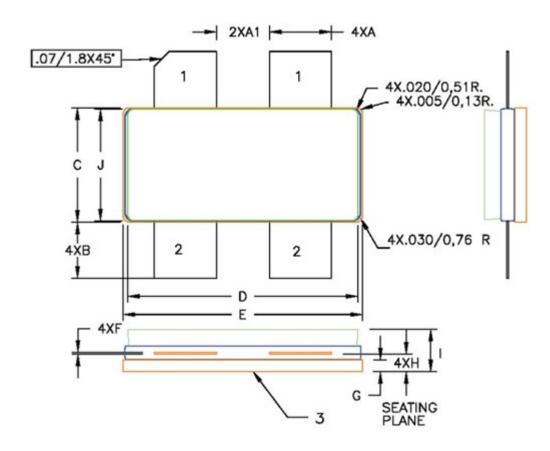


Figure 2. Power gain and drain efficiency as function of output power

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Package Outline

Flanged ceramic package; 2 mounting holes; 4 leads(1—Drain,2—Gate,3—Source)



UNIT	A	A1	В	С	D	E	F	G	Н	ı	J
	5.59	4.83	5.33	9.91	20.02	20.70	1.15	1.14	1.7	4.32	9.53
mm	5.10	4.32	4.32	9.65	19.61	20.45	0.08	0.89	1.45	3.18	9.27

OUTLINE	REFERENCE			EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	1000E BATE
PKG-VD3					28/11/2016

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Revision history

Table 5. Document revision history

Date	Revision	Datasheet Status
2016/11/28	Rev 1.0	Create Production Datasheet

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